

STPS5H100-Y

Automotive high voltage power Schottky rectifier

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Avalanche specification
- AEC-Q101 qualified

Description

This high voltage Schottky barrier rectifier is packaged in DPAK, and designed for high frequency miniature switched mode power supplies such as adaptators and on board DC to DC converters for automotive applications.

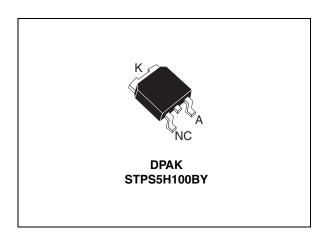


Table 1. Device summary

Symbol	Value
I _{F(AV)}	5 A
V _{RRM}	100 V
T _j (max)	175 °C
V _F (max)	0.61 V

Characteristics STPS5H100-Y

1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		100	V
I _{F(RMS)}	Forward rms current		10	Α
I _{F(AV)}	Average forward current	5	Α	
I _{FSM}	Surge non repetitive forward current	75	Α	
I _{RRM}	Repetitive peak reverse current	1	Α	
I _{RSM}	Non repetitive peak reverse current	2	Α	
P _{ARM}	Repetitive peak avalanche power	7200	W	
T _{stg}	Storage temperature range	-65 to + 175	°C	
T _j	Operating junction temperature ⁽¹⁾	-40 to +175	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

^{1.} $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	2.5	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage	T _j = 25 °C	V – V			3.5	μΑ	
'R'	current	T _j = 125 °C	$V_R = V_{RRM}$		1.3	4.5	mA
	√ _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 5 A			0.73	
V _E (2)		T _j = 125 °C			0.57	0.61	V
v F · · · · · · · · · · · · · · · · · ·	T _j = 25 °C	I _F = 10 A			0.85	V	
	T _j = 125 °C	1F - 10 A		0.66	0.71		

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

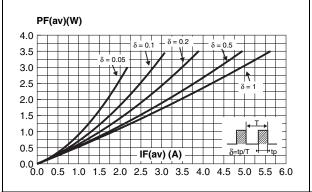
To evaluate the conduction losses use the following equation:

$$P = 0.51 \times I_{F(AV)} + 0.02I_{F}^{2}(RMS)$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

STPS5H100-Y Characteristics

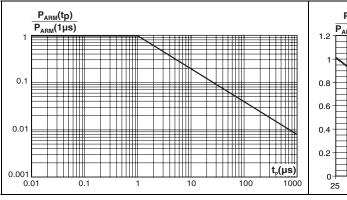
Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature (δ = 0.5)



IF(av)(A) 6 Rth(j-a)=Rth(j-c) 5 Rth(j-a)=80°C/W 3 2 Tamb(°C) 0 80 100 120 140 160 20 40 60 180

Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature



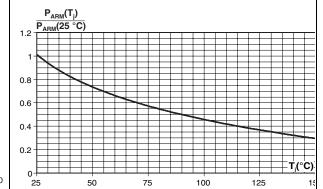
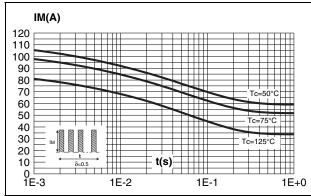
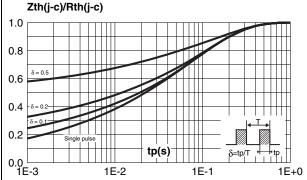


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration

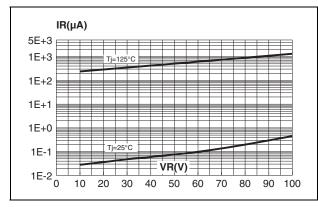




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Figure 7. Reverse leakage current versus reverse voltage applied

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



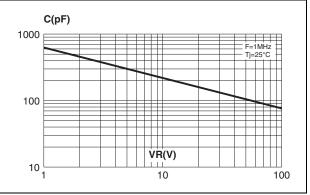
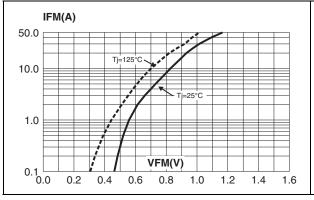
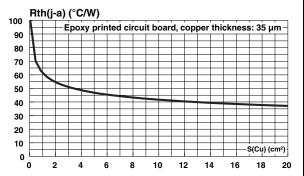


Figure 9. Forward voltage drop versus forward current (maximum values)

Figure 10. Thermal resistance junction to ambient versus copper surface under tab





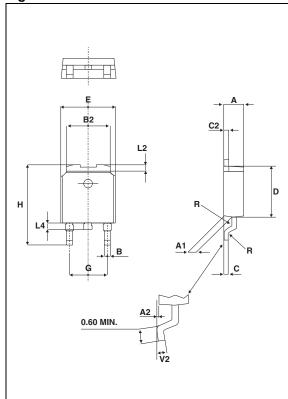
4/7 Doc ID 17744 Rev 1

2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

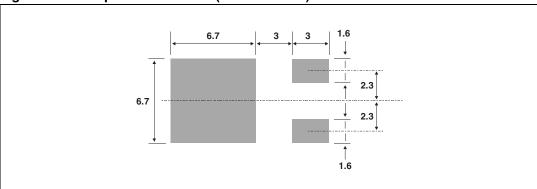
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 11. DPAK dimensions



Dimensions			
Ref Millimeters Min. Max.		Inches	
		Min.	Max.
2.20	2.40	0.086	0.094
0.90	1.10	0.035	0.043
0.03	0.23	0.001	0.009
0.64	0.90	0.025	0.035
5.20	5.40	0.204	0.212
0.45	0.60	0.017	0.023
0.48	0.60	0.018	0.023
6.00	6.20	0.236	0.244
6.40	6.60	0.251	0.259
4.40	4.60	0.173	0.181
9.35	10.10	0.368	0.397
0.80 typ.		0.03	1 typ.
0.60	1.00	0.023	0.039
0°	8°	0°	8°
	Min. 2.20 0.90 0.03 0.64 5.20 0.45 0.48 6.00 6.40 4.40 9.35 0.80 0.60	Min. Max. 2.20 2.40 0.90 1.10 0.03 0.23 0.64 0.90 5.20 5.40 0.45 0.60 0.48 0.60 6.00 6.20 6.40 4.60 9.35 10.10 0.80 typ. 0.60 1.00	Millimeters Inc. Min. Max. Min. 2.20 2.40 0.086 0.90 1.10 0.035 0.03 0.23 0.001 0.64 0.90 0.025 5.20 5.40 0.204 0.45 0.60 0.017 0.48 0.60 0.018 6.00 6.20 0.236 6.40 6.60 0.251 4.40 4.60 0.173 9.35 10.10 0.368 0.80 typ. 0.03 0.60 1.00 0.023

Figure 12. Footprint dimensions (in millimeters)



Ordering information STPS5H100-Y

3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS5H100BY-TR	S5H100Y	DPAK	0.30 g	2500	Tape and reel

4 Revision history

Table 6. Document revision history

Date	Revision	Changes
07-Nov-2011	1	Initial release.

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